IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Cazuaki Ano

Docket No.: TI-33184

Serial No. 09/930,361

Examiner: Landau, M.

Filed: 08/15/2001

Art Unit:

2815

For Low Profile Ball-Grid Array Package - For High Power

Conf. No.:

3433

TRANSMITTAL OF FORMAL DRAWINGS

Assistant Commissioner For Patents Attn: Official Drafts Person Washington, DC 20231

MAILING CERTIFICATE UNDER 37 C.F.R. § 1.8(a)

I hereby certify that the above correspondence is being deposited with the U.S. Postal/Service as First Class Mail in an envelope addressed to: Assistant Commissioner For Patents, Washington, DC 20231

Dear Sir:

Submitted herewith are <u>4</u> sheets of formal drawings.

The enclosed drawings are being provided in a timely manner therefore no additional fee is required.

Texas Instruments Incorporated P. O. Box 655474, MS 3999 Dallas, Texas 75265 (972) 917-5653

Respectfully submitted,

Michael K. Skrehot

Attorney for Applicants

Reg. No.: 36,682HNGLOGY CENTER 2800